



## PC POWER-SUPPLY SUPERVISORS

### **FEATURES**

- Over-Voltage Protection and Lockout: 12V, 5V, and 3.3V Supplies
- Over-Current Protection and Lockout: 12V, 5V, and 3.3V Supplies
- Under-Voltage Protection and Lockout: 12V Supplies
- Under-Voltage Detect: 5V and 3.3V Supplies
- Fault-Protection Output with Open-Drain Output Stage
- Open-Drain, Power-Good Output Signal: Monitors Power-Good Signal Input 3.3V and 5V Supplies
- 300ms Power-Good Delay
- 75ms Delay: 5V, 3.3V Power-Supply Short-Circuit Turn-On Protection
- 2.3ms PSON Control To FPO Turn-Off Delay
- 38ms PSON Control Debounce
- Wide Supply Voltage Range: 4.5V to 15V

### DESCRIPTION

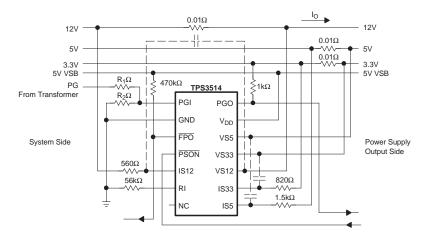
The TPS3514 is a PC switching power-supply system monitor with minimum external components. It provides under-voltage lockout (UVLO), over-voltage (OV), under-voltage (UV), over-current (OC) protection circuits, power-good indicator, and on/off control.

UVLO thresholds are 4.45V (on) and 3.65V (off). Over-current protection (OCP) and over-voltage protection (OVP) monitor 3.3V, 5V, and 12V supplies. When an OC or OV condition is detected, the power-good output (PGO) is asserted low and the fault protection output (FPO) is latched high. PSON from low-to-high resets the latch. The OCP function will be enabled 75ms after PSON goes LOW with PGI HIGH and a debounce of typically 38ms. A built-in 2.3ms delay with 38ms debounce from PSON to FPO output is enabled at turn-off.

An external resistor is connected between the RI pin and the GND pin. This will program a precise  $I_{(REF)}$  for OCP function. The programmable  $I_{(REF)}$  range is from 12.5µA to 62.5µA. Three OCP comparators and the  $I_{(REF)}$  section are supplied by VS12. The current draw from the VS12 pin is less than 1mA.

The power-good feature monitors PGI, the 3.3V and 5V supplies, and issues a power-good signal when the output is ready.

The TPS3514 is characterized for operation from –40°C to +85°C. The TPS3514 is available in DIP-14 and SO-14 packages.



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This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### PACKAGE/ORDERING INFORMATION

| PRODUCT | PACKAGE-LEAD | PACKAGE<br>DESIGNATOR (1) | SPECIFIED<br>TEMPERATURE<br>RANGE | PACKAGE<br>MARKING | ORDERING<br>NUMBER | TRANSPORT<br>MEDIA, QUANTITY |
|---------|--------------|---------------------------|-----------------------------------|--------------------|--------------------|------------------------------|
|         | SO-14        | 0                         |                                   |                    | TPS3514D           | Rails, 50                    |
| TPS3514 |              | В                         | 40°C to +85°C                     | TPS3514            | TPS3514DR          | Tape and Reel, 2500          |
|         | DIP-14       | N                         |                                   |                    | TPS3514N           | Rails, 25                    |

<sup>(1)</sup> For the most current package and ordering information see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.

### **ABSOLUTE MAXIMUM RATINGS**

over operating free-air temperature range (unless otherwise noted) (1)(2)

|                                                      | UNIT                          |
|------------------------------------------------------|-------------------------------|
| Supply Voltage, VDD                                  | 16V                           |
| Voltage on PSON, IS5, IS33, PGI                      | 8V                            |
| Voltage on VS33, VS5                                 | 16V                           |
| Voltage on FPO                                       | 16V                           |
| Voltage on PGO                                       | 8V                            |
| All Other Pins                                       | -0.3V to 16V                  |
| Continuous Total Power Dissipation                   | See Dissipation Ratings Table |
| Operating Free-Air Temperature Range, T <sub>A</sub> | −40°C to +85°C                |
| Storage Temperature Range, T <sub>stg</sub>          | −65°C to +150°C               |
| Soldering Temperature                                | 260°C                         |

<sup>(1)</sup> Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

<sup>(2)</sup> All voltage values are with respect to GND.



### **RECOMMENDED OPERATING CONDITIONS**

At specified temperature range.

| PARAMETER                            |                               | MIN  | MAX                   | UNIT |
|--------------------------------------|-------------------------------|------|-----------------------|------|
| Supply Voltage                       | V <sub>DD</sub>               | 4.5  | 15                    | V    |
| Inputs                               | VI                            |      |                       |      |
| PSON, VS5, VS33, IS5, IS33           |                               |      | 7                     | V    |
| VS12, IS12                           |                               |      | 15                    | V    |
| PGI                                  |                               |      | VDD + 0.3V (max = 7V) | V    |
| Outputs                              | Vo                            |      |                       |      |
| FPO                                  |                               |      | 15                    | V    |
| PGO                                  |                               |      | 7                     | V    |
| Sink Current                         | I <sub>O(SINK)</sub>          |      |                       |      |
| FPO                                  |                               |      | 20                    | mA   |
| PGO                                  |                               |      | 10                    | mA   |
| Supply Voltage Rising Time           | t <sub>R</sub> <sup>(1)</sup> | 1    |                       | ms   |
| OCP Reference Source                 | I <sub>(REF)</sub>            | 12.5 | 62.5                  | μΑ   |
| Operating Free-Air Temperature Range | T <sub>A</sub>                | -40  | +85                   | °C   |

<sup>(1)</sup>  $V_{DD}$  rising and falling slew rate must be less than 14V/ms.

### **DISSIPATION RATINGS TABLE**

| PACKAGE | PACKAGE T <sub>A</sub> ≤ +25°C POWER RATING |           | T <sub>A</sub> = +70°C<br>POWER RATING | T <sub>A</sub> = +85°C<br>POWER RATING |
|---------|---------------------------------------------|-----------|----------------------------------------|----------------------------------------|
| D       | 956mW                                       | 7.65mW/°C | 612mW                                  | 497mW                                  |
| N       | 1512mW 12.1mW/°C                            |           | 968mW                                  | 786mW                                  |

### **OVER-CURRENT PROTECTION**

|      | MAX OUTPUT CURRENT | OVER-CURRENT PROTECTION TRIP POINT (1) |
|------|--------------------|----------------------------------------|
| 12V  | 6A                 | 9.2A                                   |
| 5V   | 16A                | 24.6A                                  |
| 3.3V | 9A                 | 13.5A                                  |

<sup>(1)</sup> Over-current protection trip point can be programmable.



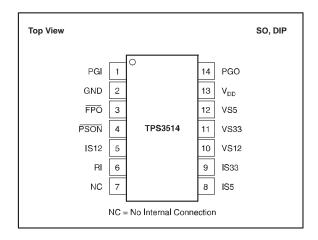
### **ELECTRICAL CHARACTERISTICS**

Limits apply over operating free-air temperature range,  $T_A = -40^{\circ}C$  to +85°C, unless otherwise noted.

|                                                                                                                |                      |                                         |                      | TPS3514              |                    |      |  |  |
|----------------------------------------------------------------------------------------------------------------|----------------------|-----------------------------------------|----------------------|----------------------|--------------------|------|--|--|
| PARAMETER                                                                                                      |                      | CONDITIONS                              | MIN                  | TYP                  | MAX                | UNIT |  |  |
| OVER-VOLTAGE AND OVER-CURI                                                                                     | RENT PROTEC          | CTION                                   |                      |                      |                    |      |  |  |
| Over-Voltage Threshold                                                                                         |                      |                                         |                      |                      |                    |      |  |  |
| VS33                                                                                                           |                      |                                         | 3.7                  | 3.9                  | 4.1                | V    |  |  |
| VS5                                                                                                            |                      |                                         | 5.7                  | 6.1                  | 6.5                | V    |  |  |
| VS12                                                                                                           |                      |                                         | 13.2                 | 13.8                 | 14.4               | V    |  |  |
| Ratio of Current Sense Sink<br>Current to Current Sense Setting<br>Pin (RI) Source Current, I <sub>(REF)</sub> | С                    | Resistor at RI = 30kΩ, 0.1%<br>Resistor | 7.6                  | 8                    | 8.4                |      |  |  |
| Leakage Current (FPO)                                                                                          | I <sub>lkg</sub>     | V <sub>(FPO)</sub> = 5V                 |                      |                      | 5                  | μΑ   |  |  |
| Low-Level Output Voltage (FPO)                                                                                 | V <sub>OL</sub>      | $I_{(SINK)} = 20mA$ , $V_{DD} = 5V$     |                      |                      | 0.7                | V    |  |  |
| Noise Deglitch Time (OVP)                                                                                      |                      | V <sub>DD</sub> = 5V                    | 35                   | 73                   | 110                | μs   |  |  |
| Current Source Reference<br>Voltage                                                                            | V <sub>(RI)</sub>    | $V_{DD} = 5V$                           | 1.1                  | 1.15                 | 1.2                | ٧    |  |  |
| UNDER-VOLTAGE LOCKOUT                                                                                          |                      |                                         |                      |                      |                    |      |  |  |
| Start Threshold Voltage                                                                                        |                      |                                         |                      |                      | 4.45               | V    |  |  |
| Minimum Operating Voltage After Sta                                                                            | art-Up               |                                         | 3.65                 |                      |                    | V    |  |  |
| PGI AND PGO                                                                                                    |                      |                                         |                      |                      |                    |      |  |  |
| Input Threshold                                                                                                | V <sub>IT(PGI)</sub> |                                         | 0.9 x typ            | 1.15                 | 1.01 x typ         | V    |  |  |
| Under-Voltage Threshold                                                                                        | , ,                  |                                         |                      |                      |                    |      |  |  |
| VS33                                                                                                           |                      |                                         | 2                    | 2.2                  | 2.4                | V    |  |  |
| VS5                                                                                                            |                      |                                         | 3.3                  | 3.5                  | 3.7                | V    |  |  |
| VS12                                                                                                           |                      |                                         | 8.5                  | 9                    | 9.5                | V    |  |  |
| Input Offset Voltage for OCP Compa                                                                             | rators               |                                         |                      |                      | 5                  | mV   |  |  |
| Leakage Current (PGO)                                                                                          | I <sub>lkg</sub>     | PGO = 5V                                |                      |                      | 5                  | μΑ   |  |  |
| Low-Level Output Voltage (PGO)                                                                                 | V <sub>OL</sub>      | $I_{(SINK)} = 10mA, V_{DD} = 4.5V$      |                      |                      | 0.4                | V    |  |  |
| Short-Circuit Protection Delay                                                                                 | 3.3V, 5V             | ,                                       | 49                   | 75                   | 114                | ms   |  |  |
| Delay Time                                                                                                     | t <sub>(d)(1)</sub>  |                                         |                      |                      |                    |      |  |  |
| PGI to PGO                                                                                                     | (3)(7)               | $V_{DD} = 5V$                           | 200                  | 300                  | 450                | ms   |  |  |
| PGI to FPO                                                                                                     |                      | $V_{DD} = 5V$                           | 3.2                  | 4.8                  | 7.2                | ms   |  |  |
| Noise Deglitch Time                                                                                            |                      |                                         |                      |                      |                    |      |  |  |
| PGI to PGO                                                                                                     |                      | $V_{DD} = 5V$                           | 88                   | 150                  | 225                | μs   |  |  |
| 12V UVP to FPO                                                                                                 |                      | $V_{DD} = 5V$                           | 88                   | 150                  | 225                | μs   |  |  |
| PSON CONTROL                                                                                                   |                      |                                         |                      |                      |                    |      |  |  |
| Input Pull-Up Current                                                                                          | I <sub>1</sub>       | PSON = 0V                               |                      | -120                 |                    | μΑ   |  |  |
| High-Level Input Voltage                                                                                       | V <sub>IH</sub>      |                                         | 2.4                  |                      |                    | ٧    |  |  |
| Low-Level Input Voltage                                                                                        | V <sub>IL</sub>      |                                         |                      |                      | 1.2                | V    |  |  |
| Debounce Time (PSON)                                                                                           | t <sub>(b)</sub>     | $V_{DD} = 5V$                           | 24                   | 38                   | 50                 | ms   |  |  |
| Delay Time (PSON to FPO)                                                                                       | t <sub>(d)(2)</sub>  | $V_{DD} = 5V$                           | t <sub>b</sub> + 1.1 | t <sub>b</sub> + 2.3 | t <sub>b</sub> + 4 | ms   |  |  |
| TOTAL DEVICE                                                                                                   | (-/(-/               |                                         |                      |                      |                    |      |  |  |
| Supply Current                                                                                                 | $I_{DD}$             | PSON = 5V                               |                      |                      | 1                  | mA   |  |  |



### **PIN CONFIGURATION**



### **PIN ASSIGNMENTS**

| PIN | NAME     | FUNCTION                                                   |
|-----|----------|------------------------------------------------------------|
| 3   | FPO      | Inverted Fault Ptotection output. Open-drain output stage. |
| 2   | GND      | Ground                                                     |
| 5   | IS12     | 12V Over-Current Protection Input                          |
| 8   | IS5      | 5V Over-Current Protection Input                           |
| 9   | IS33     | 3.3V Over-Current Protection Input                         |
| 7   | NC       | No Internal Connection                                     |
| 1   | PGI      | Power-Good Input                                           |
| 14  | PGO      | Power-Good Output. Open-drain output stage.                |
| 4   | PSON     | On/Off Control Input                                       |
| 6   | RI       | OCP Reference Source                                       |
| 13  | $V_{DD}$ | Supply Voltage                                             |
| 10  | VS12     | 12V Over-Voltage/Under-Voltage Protection Input            |
| 11  | VS33     | 3.3V Over-Voltage/Under-Voltage Protection Input           |
| 12  | VS5      | 5V Over-Voltage/Under-Voltage Protection Input             |

### **FUNCTION TABLE**(1)

| PGI    | PSON | UV CONDITION<br>3.3V/5V | OV CONDITIONS | UV CONDITION 12V<br>OC CONDITIONS | FPO (2) | PGO <sup>(3)</sup> |
|--------|------|-------------------------|---------------|-----------------------------------|---------|--------------------|
| < 0.9V | L    | No                      | No            | No                                | L       | L                  |
| < 0.9V | L    | No                      | No            | Yes                               | L       | L                  |
| < 0.9V | L    | No                      | Yes           | No                                | Н       | L                  |
| < 0.9V | L    | No                      | Yes           | Yes                               | Н       | L                  |
| < 0.9V | L    | Yes                     | No            | No                                | L       | L                  |
| < 0.9V | L    | Yes                     | No            | Yes                               | L       | L                  |
| < 0.9V | L    | Yes                     | Yes           | No                                | Н       | L                  |
| < 0.9V | L    | Yes                     | Yes           | Yes                               | Н       | L                  |
| > 1.2V | L    | No                      | No            | No                                | L       | Н                  |
| > 1.2V | L    | No                      | No            | Yes                               | Н       | L                  |
| > 1.2V | L    | No                      | Yes           | No                                | Н       | L                  |
| > 1.2V | L    | No                      | Yes           | Yes                               | Н       | L                  |
| > 1.2V | L    | Yes                     | No            | No                                | Н       | L                  |
| > 1.2V | L    | Yes                     | No            | Yes                               | Н       | L                  |
| > 1.2V | L    | Yes                     | Yes           | No                                | Н       | L                  |
| > 1.2V | L    | Yes                     | Yes           | Yes                               | Н       | L                  |
| x      | Н    | x                       | x             | x                                 | Н       | L                  |

- (1) x = Don't Care.
- (2) For FPO, L = Fault is not latched. H = Fault is latched.
   (3) For PGO, L = Fault. H = No Fault.



### **TIMING DIAGRAMS**

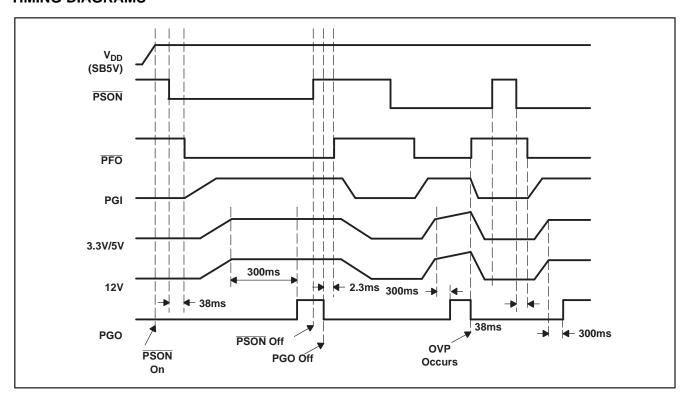


Figure 1. AC Turn-On and Over-Voltage Protect

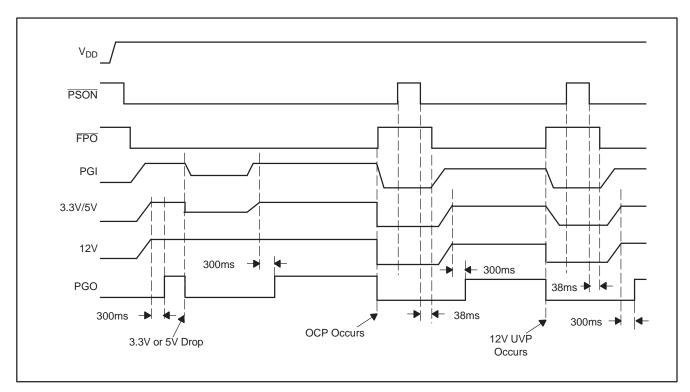
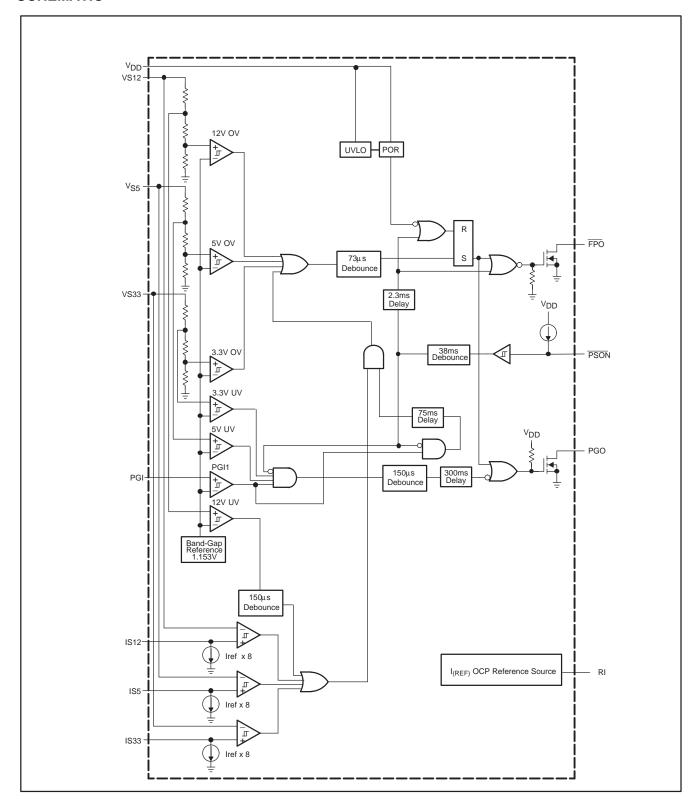


Figure 2. Over-Current and Under-Voltage Detect/Protect



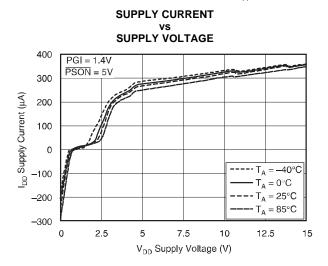
### **SCHEMATIC**



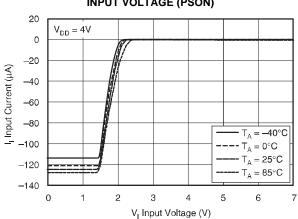


### TYPICAL CHARACTERISTICS

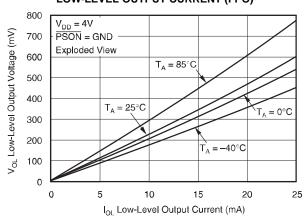
 $T_{\Delta}$  = +25°C, unless otherwise noted.



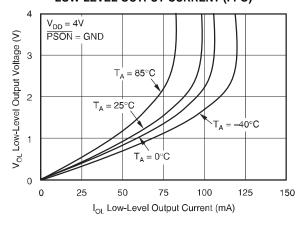
INPUT CURRENT (PSON)
vs
INPUT VOLTAGE (PSON)



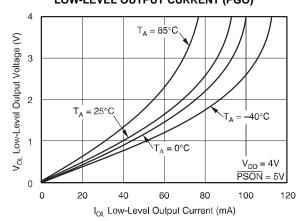
# LOW-LEVEL OUTPUT VOLTAGE (FPO) vs LOW-LEVEL OUTPUT CURRENT (FPO)



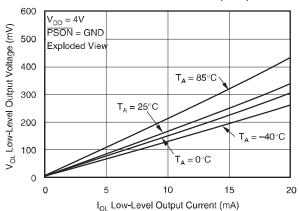
LOW-LEVEL OUTPUT VOLTAGE (FPO)
vs
LOW-LEVEL OUTPUT CURRENT (FPO)



# LOW-LEVEL OUTPUT VOLTAGE (PGO) vs LOW-LEVEL OUTPUT CURRENT (PGO)



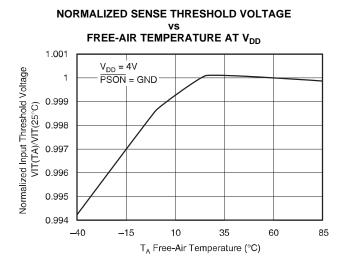
# LOW-LEVEL OUTPUT VOLTAGE (PGO) vs LOW-LEVEL OUTPUT CURRENT (PGO)

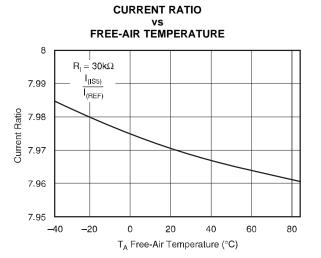




### TYPICAL CHARACTERISTICS (continued)

 $T_{\Delta} = +25^{\circ}C$ , unless otherwise noted.





### **DETAILED DESCRIPTION**

### **Power-Good Delay**

A PC power supply is commonly designed to provide a power-good signal, which is defined by the computer manufacturers. Power-Good Output (PGO) is a power-good indicator and should be asserted high by the PC power supply to indicate that the 5VDC and 3.3VDC outputs are above the under-voltage threshold limit. At this time, the supply should be able to provide enough power to assure continuous operation within the specification.

Conversely, when either the 5VDC or the 3.3VDC output voltages fall below the under-voltage threshold, or when main power has been removed for a sufficiently long time so that power-supply operation is no longer assured, PGO should be deasserted to a low state. The power-good, DC enable (PSON), and the 5V/3.3V supply rails are shown in Figure 3.

Although there is no requirement to meet specific timing parameters, the following signal timings are recommended:

2ms 
$$\le$$
  $t_2$   $\le$  20ms, 100ms  $<$   $t_3$   $<$  2000ms,  $t_4$   $>$  1ms,  $t_5$   $\le$  10ms

Furthermore, motherboards should be designed to comply with the above recommended timing. If timings other than these are implemented or required, this information should be clearly specified.

The TPS3514 family of power-supply supervisors provides a PGO for the 3.3V and 5V supply voltage rails and a separate Power-Good Input (PGI). An internal timer is used to generate a 300ms power-good delay.

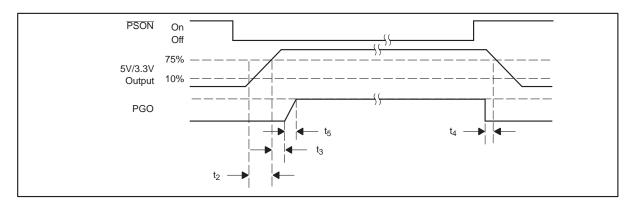


Figure 3. Timing of PSON and PGO



If the voltage signals at PGI, VS33, and VS5 rise above the under-voltage threshold, the open-drain PGO will go high after a delay of 300ms. When the PGI voltage or any of the 3.3V/5V rail drops below the under-voltage threshold, PGO will be disabled immediately.

# Power-Supply Remote On/Off (PSON) And Fault Protect Output (FPO)

Since the latest personal computer generation focuses on easy turn-on and power-saving functions, the PC power supply will require two characteristics. One is a DC power-supply remote on/off function; the other is standby voltage to achieve very low power consumption of the PC system. Thus, requiring the main power supply to be shut down.

The power-supply remote on/off (PSON) is an active-low signal that turns on all of the main power rails including the 3.3V, 5V, -5V, and -12V power rails. When this signal is held high by the PC motherboard or left open-circuited, the signal of the Fault Protect Output (FPO) also goes high. In this condition, the main power rails should not deliver current and should be held at 0V.

When the FPO signal is held high due to an occurring fault condition, the fault status will be latched and the outputs of the main power rails should not deliver current and should be held at 0V. Toggling PSON from low to high will reset the fault protection latch. During this fault condition, only the standby power is not affected.

When PSON goes from high to low or low to high, the 38ms debounce block will prevent a glitch on the input from disabling/enabling the FPO output. During the HIGH to LOW transition, the under-voltage function is disabled to prevent turn-on failure.

Power should be delivered to the rails only if the PSON signal is held at ground potential, thus, FPO is active low. The FPO pin can be connected to 5VDC (or up to 15VDC) through a pull-up resistor.

### **Under-Voltage Protection (UVP)**

The TPS3514 provides Under-Voltage Protection (UVP) for the 12V rail and Under-Voltage Detect (UVD) for the 3.3V and 5V rails. When an under-voltage condition appears at the VS12 input pin for more than 150 $\mu$ s, the FPO output goes high and PGO goes low. Also, this fault condition will be latched until PSON is toggled from low to high or VDD is removed.

### **Over-Current Protection (OCP)**

In bridge, or forward type, off-line switching power supplies, usually designed for medium to large power, the overload protection design needs to be very precise. Most of these types of power supplies sense the output current for an overload condition. The trigger-point needs to be set higher than the maximum load in order to prevent false turn-on.

The TPS3514 provides Over-Current Protection (OCP) for the 3.3V, 5V, and 12V rails. When an over-current condition appears at the OCP comparator input pins for more than 73 $\mu$ s, the FPO output goes high and PGO goes low. Also, this fault condition will be latched until PSON is toggled from low to high or V<sub>DD</sub> is removed.

The resistor connected between the RI pin and the GND pin will create a precise  $I_{(REF)}$  for the OCP function. The formula for choosing the RI resistor is  $V_{(RI)}/I_{(REF)}$ . The  $I_{(REF)}$  range is from 12.5 $\mu$ A to 62.5 $\mu$ A. Three OCP comparators and the  $I_{(REF)}$  section are supplied through the V12 pin. Current drawn from the VS12 pin is less than 1mA.

Following is an example on calculating OCP for the 12V rail:

RI = 
$$V_{(RI)}/I_{(REF)}$$
 = 1.15V/20 $\mu$ A = 56k $\Omega$   
 $I_{(REF)} \bullet C \bullet R_{(IS12)} = R_{(SENSE)} \cdot I_{(OCP\_TRIP)}$   
 $I_{(OCP\_TRIP)}$  = 20 $\mu$ A • 8 • 560 $\Omega$ /0.01 $\Omega$  = 9.2A  
C = Current Ratio (typically = 8)

### **Over-Voltage Protection (OVP)**

The Over-Voltage Protection (OVP) of the TPS3514 monitors 3.3V, 5V, and 12V. When an over-voltage condition appears at one of the 3.3V, 5V, or 12V input pins for more than 73 $\mu$ s, the FPO output goes high and PGO goes low. Also, this fault condition will be latched until PSON is toggled from low-to-high or V<sub>DD</sub> is removed.

During fault conditions, most power supplies have the potential to deliver higher output voltages than those normally specified or required. In unprotected equipment, it is possible for output voltages to be high enough to cause internal or external damage of the system. To protect the system under these abnormal conditions, it is common practice to provide over-voltage protection within the power supply. www.ti.com 11-Nov-2025

### PACKAGING INFORMATION

| Orderable part number | Status | Material type | Package   Pins | Package qty   Carrier | RoHS | Lead finish/<br>Ball material | MSL rating/<br>Peak reflow | Op temp (°C) | Part marking |
|-----------------------|--------|---------------|----------------|-----------------------|------|-------------------------------|----------------------------|--------------|--------------|
|                       | (1)    | (2)           |                |                       | (3)  | (4)                           | (5)                        |              | (6)          |
| TPS3514DR             | Active | Production    | SOIC (D)   14  | 2500   LARGE T&R      | Yes  | NIPDAU                        | Level-1-260C-UNLIM         | -40 to 85    | TPS3514D     |
| TPS3514DR.A           | Active | Production    | SOIC (D)   14  | 2500   LARGE T&R      | Yes  | NIPDAU                        | Level-1-260C-UNLIM         | -40 to 85    | TPS3514D     |
| TPS3514N              | Active | Production    | PDIP (N)   14  | 25   TUBE             | Yes  | NIPDAU                        | N/A for Pkg Type           | -40 to 85    | TPS3514N     |
| TPS3514N.A            | Active | Production    | PDIP (N)   14  | 25   TUBE             | Yes  | NIPDAU                        | N/A for Pkg Type           | -40 to 85    | TPS3514N     |

<sup>(1)</sup> Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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<sup>(3)</sup> RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

<sup>(4)</sup> Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

## **PACKAGE MATERIALS INFORMATION**

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### TAPE AND REEL INFORMATION





| A0 | Dimension designed to accommodate the component width     |
|----|-----------------------------------------------------------|
| В0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

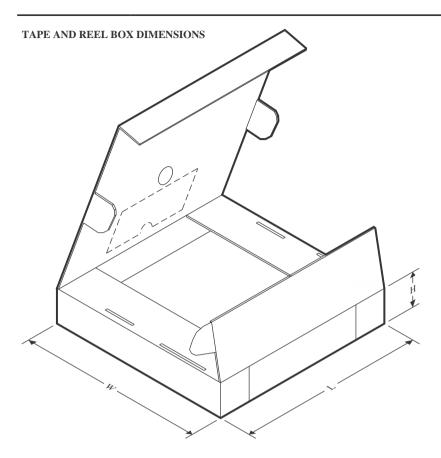


#### \*All dimensions are nominal

|   | Device    | U    | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | ` ' | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|---|-----------|------|--------------------|----|------|--------------------------|--------------------------|-----|------------|------------|------------|-----------|------------------|
| ı | TPS3514DR | SOIC | D                  | 14 | 2500 | 330.0                    | 16.4                     | 6.5 | 9.0        | 2.1        | 8.0        | 16.0      | Q1               |

# **PACKAGE MATERIALS INFORMATION**

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### \*All dimensions are nominal

| Device    | Package Type | Package Type Package Drawing |    | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-----------|--------------|------------------------------|----|------|-------------|------------|-------------|
| TPS3514DR | SOIC         | D                            | 14 | 2500 | 353.0       | 353.0      | 32.0        |

# **PACKAGE MATERIALS INFORMATION**

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### **TUBE**



### \*All dimensions are nominal

| Device     | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (µm) | B (mm) |
|------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| TPS3514N   | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| TPS3514N.A | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |



SMALL OUTLINE INTEGRATED CIRCUIT



### NOTES:

- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm, per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm, per side.
- 5. Reference JEDEC registration MS-012, variation AB.



SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



# N (R-PDIP-T\*\*)

### PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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